

DOSEMI

IGBT

DG20X06T1

600V/20A IGBT with Diode

General Description

DOSEMI IGBT Power Discrete provides ultra low conduction loss as well as low switching loss. They are designed for the applications such as general inverters and UPS.

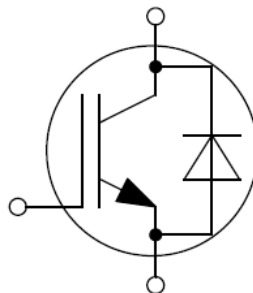
Features

- Low $V_{CE(sat)}$ Fast IGBT technology
- Low switching loss
- Maximum junction temperature 175°C
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD
- Lead free package

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	600	V
V_{GES}	Gate-Emitter Voltage	+20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	42	A
	@ $T_C=100^{\circ}\text{C}$	29	A
I_{CM}	Pulsed Collector Current t_p limited by T_{jmax}	60	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	313	W

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	600	V
I_F	Diode Continuous Forward Current	42	A
I_{FM}	Diode Maximum Forward Current t_p limited by T_{jmax}	60	A

Discrete

Symbol	Description	Values	Unit
T_{jop}	Operating Junction Temperature	-40 to +175	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^{\circ}\text{C}$
T_S	Soldering Temperature, 1.6mm from case for 10s	260	$^{\circ}\text{C}$
M	Mounting Torque, Screw M3	0.6	N.m

IGBT Characteristics $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=20\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.45	1.90	V
		$I_C=20\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.60		
		$I_C=20\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.70		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.24\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.2	5.8	6.5	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA
R_{Gint}	Internal Gate Resistance			0		Ω
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		2.32		nF
C_{res}	Reverse Transfer Capacitance				0.05	
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.14		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=20\text{A}, R_G=18\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		12		ns
t_r	Rise Time			10		ns
$t_{d(off)}$	Turn-Off Delay Time			96		ns
t_f	Fall Time			56		ns
E_{on}	Turn-On Switching Loss			0.26		mJ
E_{off}	Turn-Off Switching Loss			0.35		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=20\text{A}, R_G=18\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		12		ns
t_r	Rise Time			13		ns
$t_{d(off)}$	Turn-Off Delay Time			112		ns
t_f	Fall Time			76		ns
E_{on}	Turn-On Switching Loss			0.35		mJ
E_{off}	Turn-Off Switching Loss			0.45		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=20\text{A}, R_G=18\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$		12		ns
t_r	Rise Time			14		ns
$t_{d(off)}$	Turn-Off Delay Time			120		ns
t_f	Fall Time			80		ns
E_{on}	Turn-On Switching Loss			0.39		mJ
E_{off}	Turn-Off Switching Loss			0.47		mJ
I_{SC}	SC Data	$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=360\text{V}, V_{CEM} \leq 600\text{V}$		100		A

Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=20\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.60	2.00	V
		$I_F=20\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.55		
		$I_F=20\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.50		
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=20\text{A},$ $-di/dt=2000\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^\circ\text{C}$		1.10		μC
I_{RM}	Peak Reverse Recovery Current			33.0		A
E_{rec}	Reverse Recovery Energy			0.23		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=20\text{A},$ $-di/dt=2000\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^\circ\text{C}$		1.93		μC
I_{RM}	Peak Reverse Recovery Current			35.2		A
E_{rec}	Reverse Recovery Energy			0.41		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=20\text{A},$ $-di/dt=2000\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^\circ\text{C}$		2.42		μC
I_{RM}	Peak Reverse Recovery Current			37.4		A
E_{rec}	Reverse Recovery Energy			0.52		mJ

Discrete Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
R_{thJC}	Junction-to-Case (per IGBT)			0.480	K/W
	Junction-to-Case (per Diode)			0.910	
R_{thJA}	Junction-to-Ambient		62		K/W

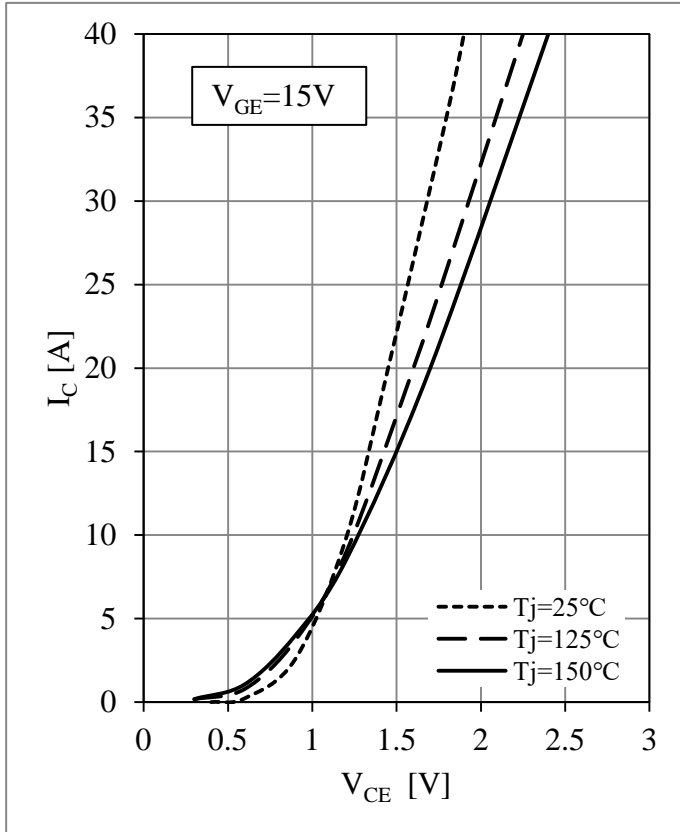


Fig 1. IGBT-inverter Output Characteristics

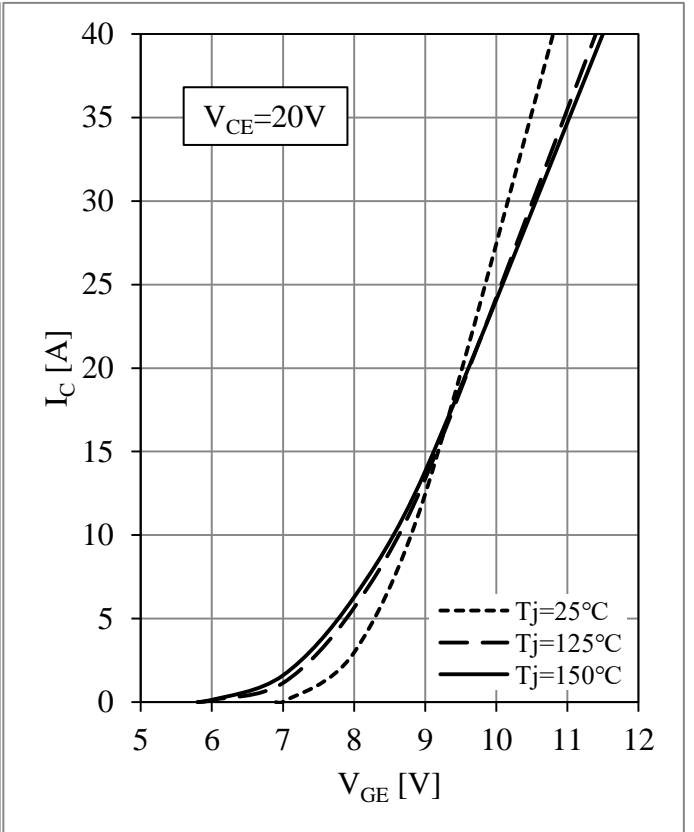


Fig 2. IGBT-inverter Transfer Characteristics

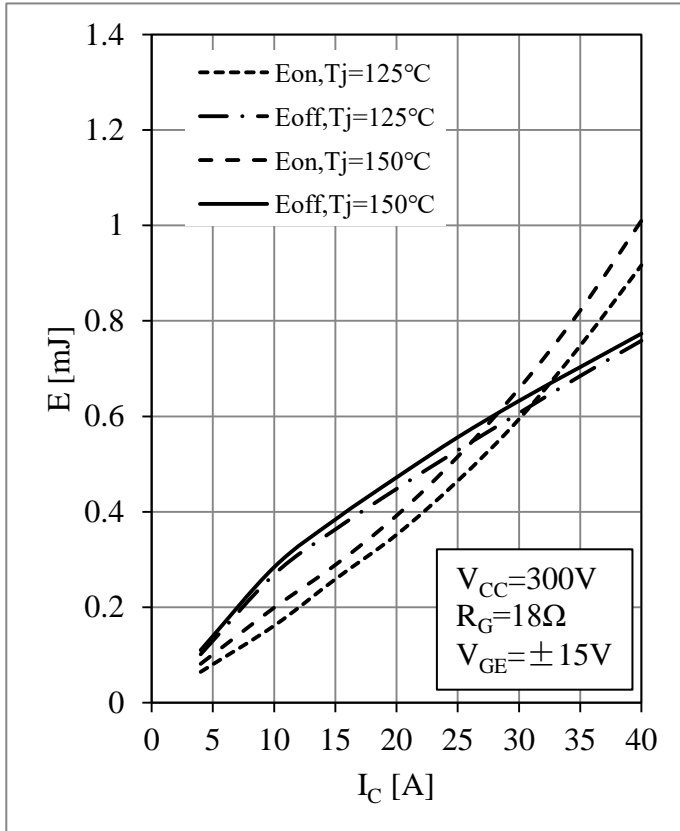


Fig 3. IGBT-inverter Switching Loss vs. I_C

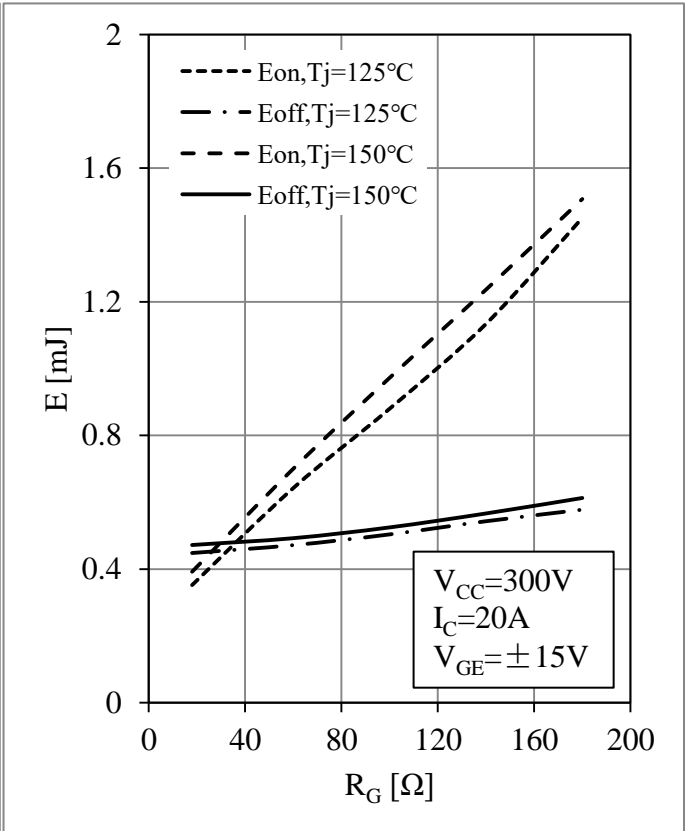


Fig 4. IGBT-inverter Switching Loss vs. R_G

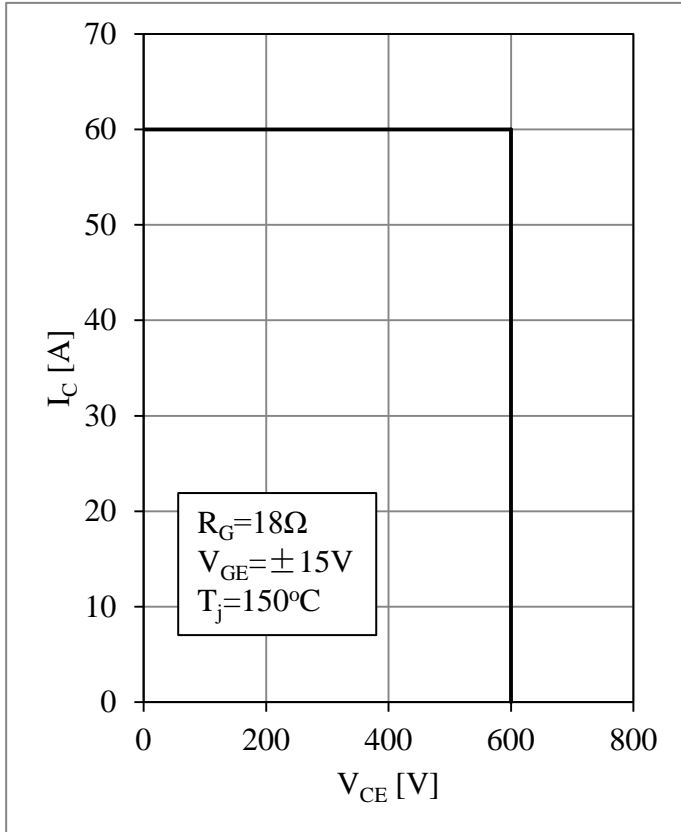


Fig 5. IGBT-inverter RBSOA

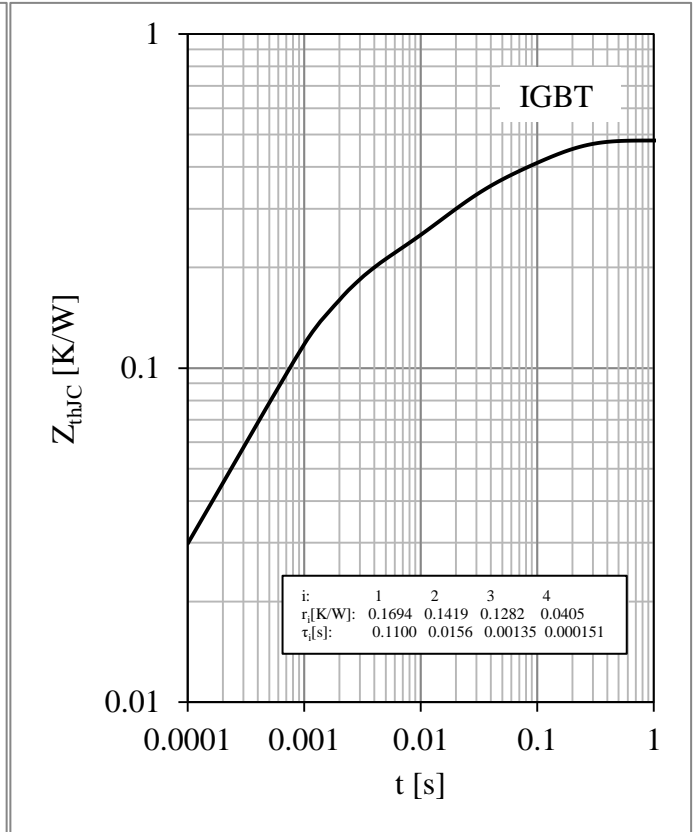


Fig 6. IGBT-inverter Transient Thermal Impedance

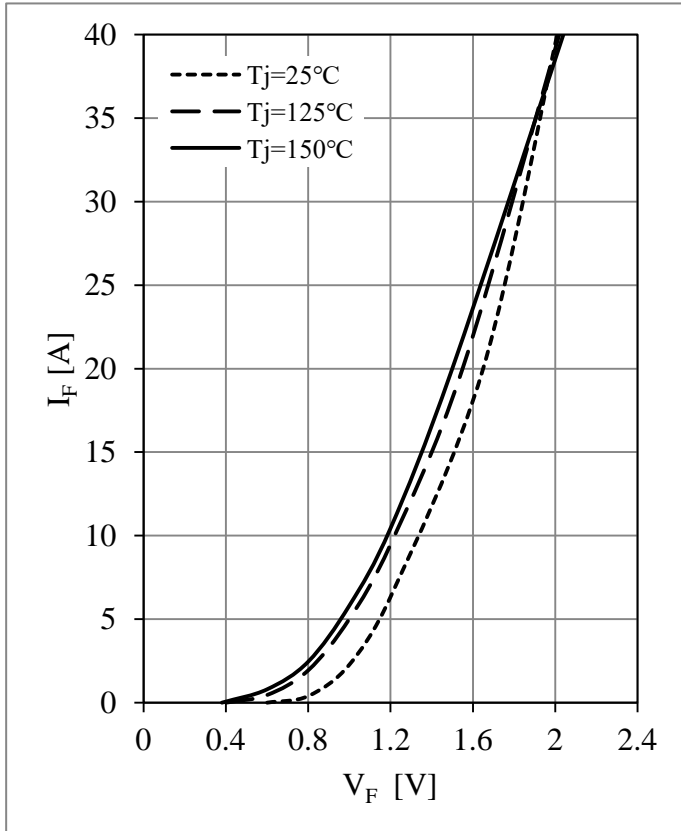


Fig 7. Diode-inverter Forward Characteristics

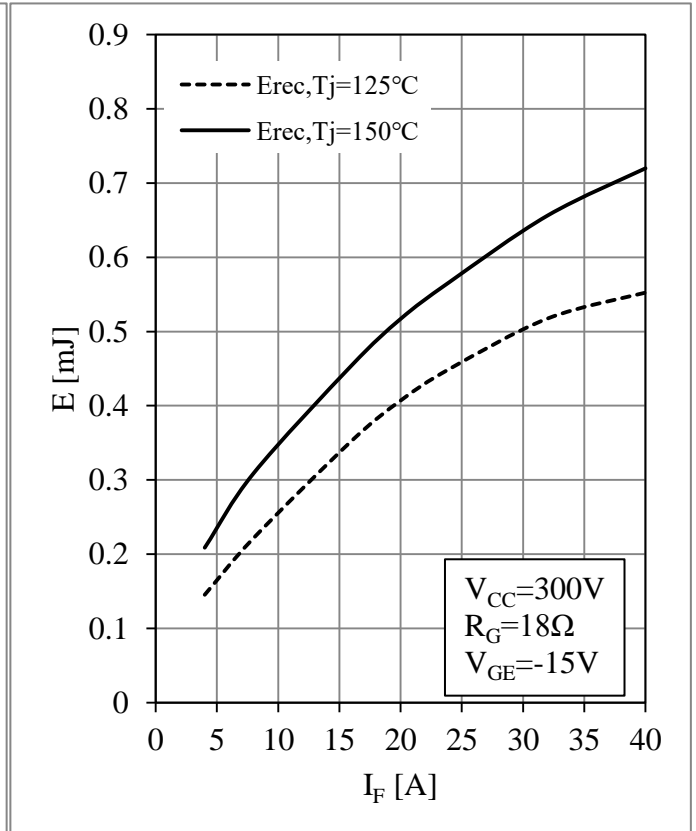


Fig 8. Diode-inverter Switching Loss vs. I_F

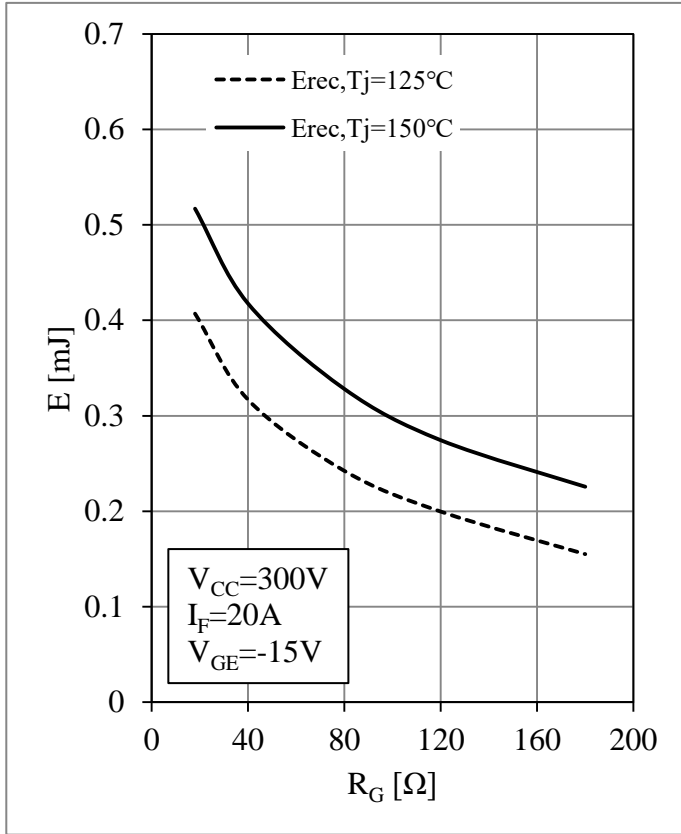


Fig 9. Diode-inverter Switching Loss vs. R_G

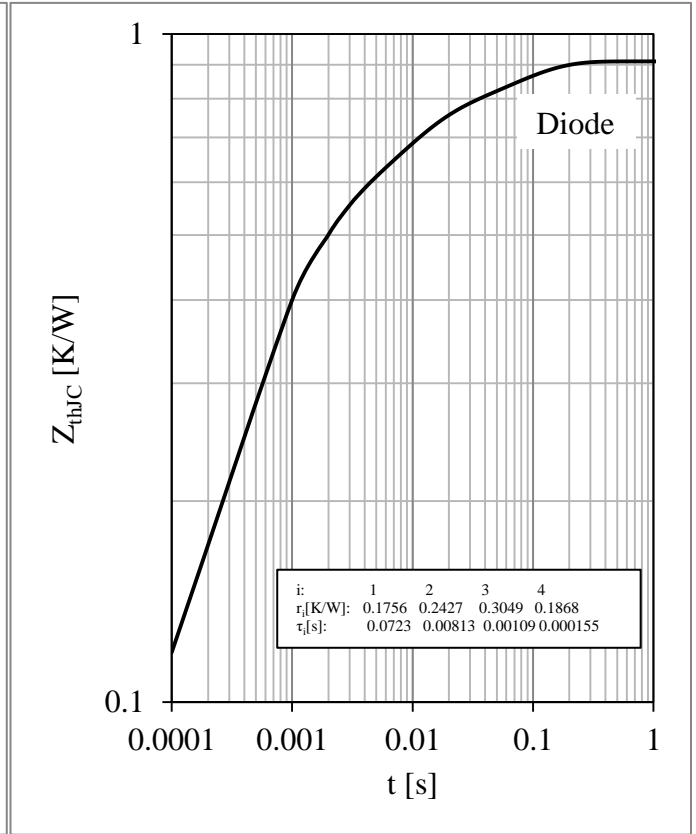
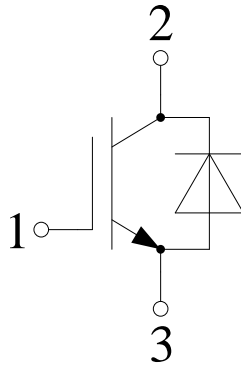


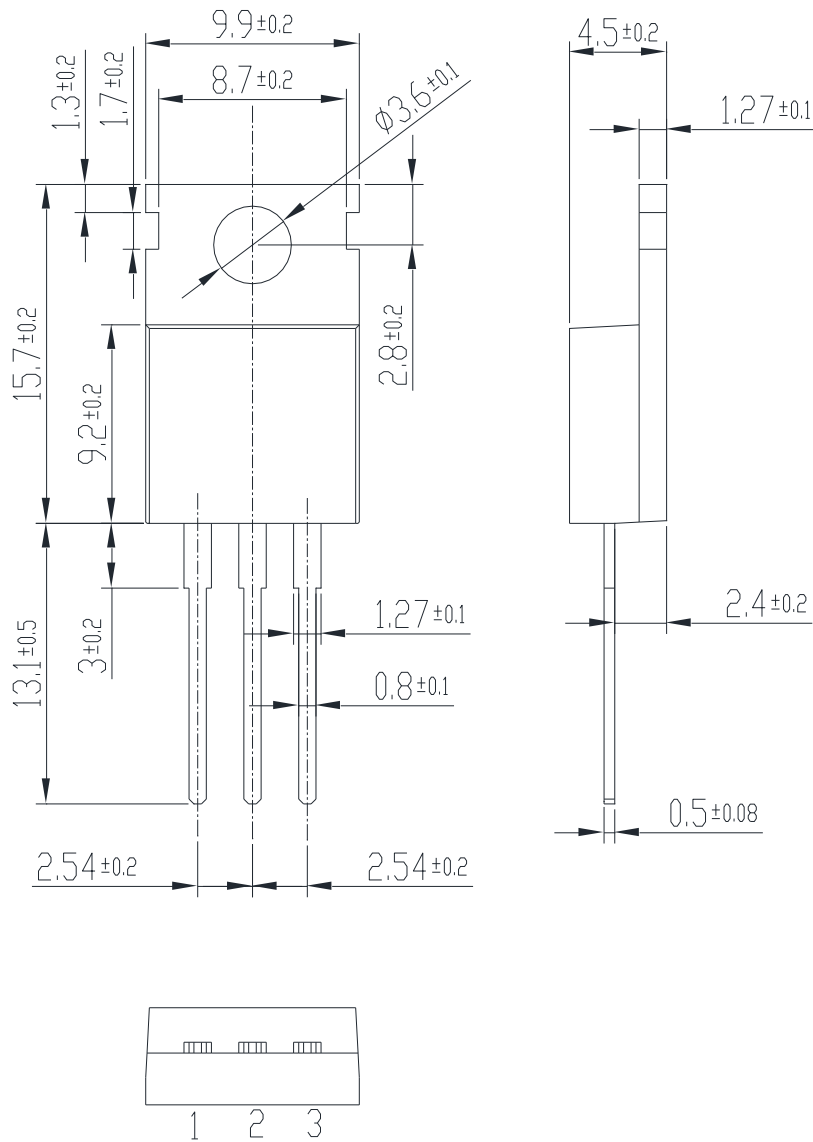
Fig 10. Diode-inverter Transient Thermal Impedance

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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